

## CARR'S AND HIGH-POWER LASER WELDING, battery interconnections and busbar systems.

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**Carr's Welding Technologies Ltd** 

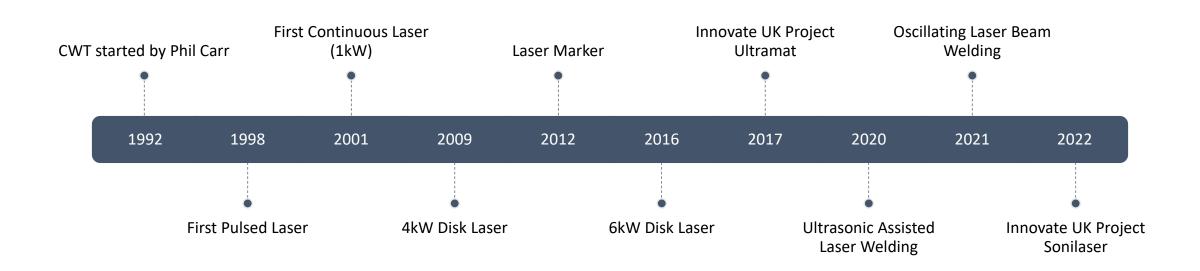
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### Summary

- Company History into laser welding
- Copper and aluminium interconnections in battery applications.
- Oscillating laser beam welding
- Typical examples interconnections
- Future developments of the nonferrous battery interconnects
- Soni-Laser project

# Company History

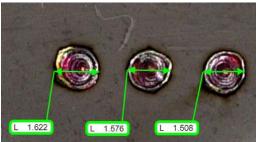


# Copper Welding and its Difficulties

Characteristics	Causes
Highly reflective especially for infrared lasers.	Inability to couple the laser beam without high power densities.
Copper's high thermal conductivity.	High heat transfer during weld means it will be harder to fuse materials together.
Ability to absorb heat increases with temperature.	Increases the chances of blowholes and spatter.
Low viscosity.	Highly sensitive to rippling.







# Current Limitations in Copper Welding

- Copper's absorptivity increases with the decrease of the laser wavelength which gives visible band lasers an advantage. However, these still don't have the sufficient power for deeper welds.
- Initial high-power requirements can be detrimental to lower thicknesses (e.g. cell terminals to busbars).
- Exceptional thermal conductivity must be controlled when near heat sensitive components.
- Internal reflections on the walls of the keyhole increase weld depths (mainly on infrared lasers)

# Oscillating Laser Beam Welding

#### **Enhanced Weld Quality & Consistency**

Superior quality when compared to conventional laser welding.

#### **Greater Tolerance for Process Variables**

Allows for wider process parameters such as gaps.

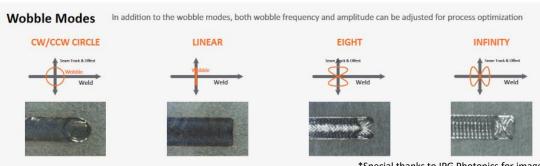
#### **Improved Welding of Dissimilar Materials**

Wobble parameters allow for better control of the melting and solidification which improves weldability.

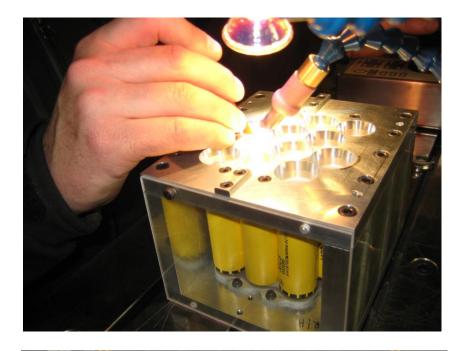
#### Welding Materials Prone to Cracking/Porosity

Delayed solidification and re-melting minimise stress build up which reduces the cracking phenomenon from occurring.

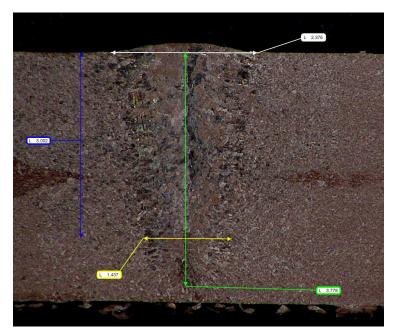




\*Special thanks to IPG Photonics for image









Examples of laser welds in module interconnects.

### Thank You For Listening



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